

3.0mmx1.0 mm RIGHT ANGLE INFRARED **EMITTING DIODE**

Part Number: KPA-3010F3C

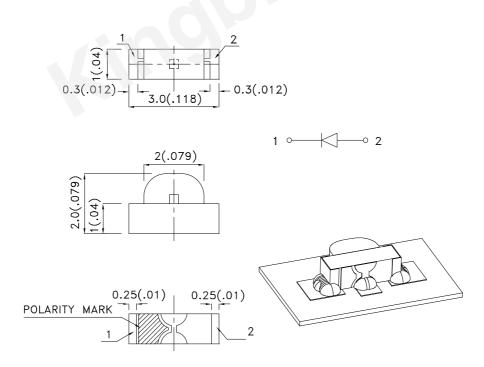
Features

- 3.0mmx1.0mm right angle SMT LED, 2.0mm thickness.
- Mechanically and spectrally matched to phototransistor.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions



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- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4.The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.16A

CHECKED: Allen Liu

DATE: OCT/28/2013

DRAWN: D.N.Huang

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Selection Guide

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPA-3010F3C	F3 (GaAs)	Water Clear	1.2	3	- 120°
			*0.8	*2	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions	
Forward Voltage [1]	F3	VF	1.2	1.6	V	IF=20mA	
Reverse Current	F3	lr		10	uA	V _R = 5V	
Capacitance	F3	С	90		pF	VF=0V;f=1MHz	
Peak Spectral Wavelength	F3	λP	940		nm	IF=20mA	
Spectral Bandwidth	F3	Δλ1/2	50		nm	IF=20mA	

Notes:

1.Forward Voltage: +/-0.1V.

2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

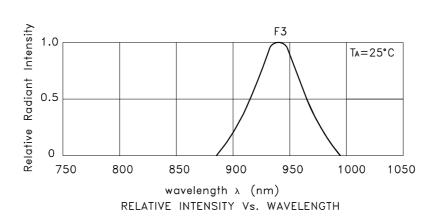
Absolute Maximum Ratings at TA=25°C

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Parameter	Symbol	F3	Units			
Power dissipation	Po	80	mW			
DC Forward Current	lF	50	mA			
Peak Forward Current [1]	iFS	1.2	А			
Reverse Voltage	VR	5	V			
Operating Temperature	Та	-40 To +85	°C			
Storage Temperature	Тѕтс	-40 To +85	°C			

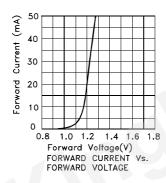
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

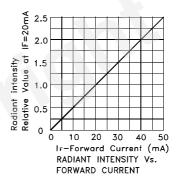
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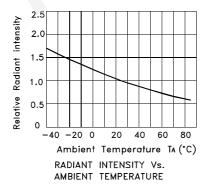
^{2.} Radiant Intensity/ luminous flux: +/-15%.
*Radiant Intensity value is traceable to the CIE127-2007 compliant national standards.

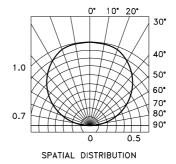


KPA-3010F3C







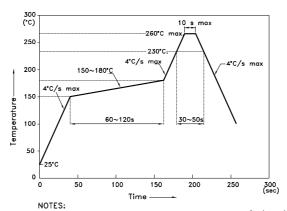


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KPA-3010F3C

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

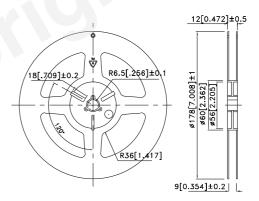
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

 3.Number of reflow process shall be 2 times or less.

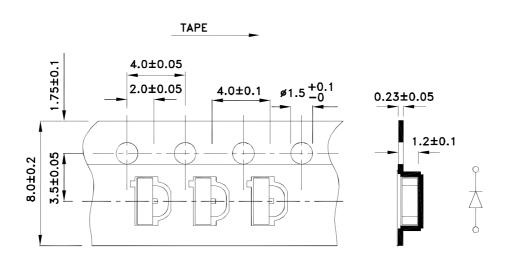
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

0.9

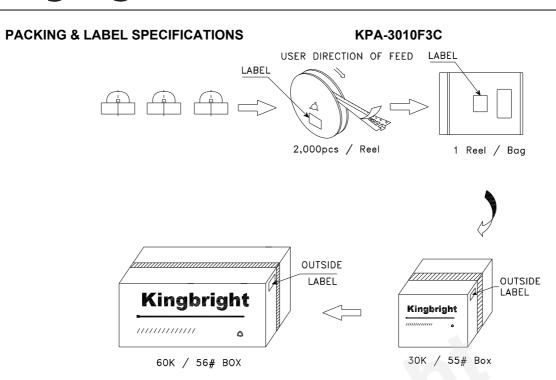
Reel Dimension

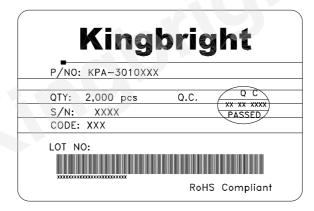


Tape Specifications (Units: mm)



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6.Detailed application notes are listed on our website. http://www.kingbright.com/application_notes

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